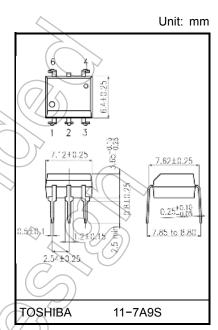
TOSHIBA Photocoupler IRED & Photo-Triac

# **TLP3064(S)**

Office Machine Household Use Equipment **Triac Driver** Solid State Relay

The TOSHIBA TLP3064(S) consists of a zero voltage crossing turn-on photo-triac optically coupled to an infrared emitting diode in a six lead plastic DIP package.

- Peak off-state voltage: 600V(min.)
- Trigger LED current: 3mA(max.)
- On-state current: 100mA(max.)
- Isolation voltage: 5000Vrms(min.)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349
- VDE-approved: EN 60747-5-5, EN 62368-1 (Note 1)



Weight: 0.39 g(typ.)

Pin Configurations(top view)

Note 1: When a VDE approved type is needed, please designate the Option(D4).

7.62mm pitch

10.16mm pitch

standard type

(LF2)type

Creepage distance: 7.0mm(min.)

8.0mm(min.)

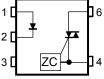
Clearance: 7.0mm(min.)

8.0mm(min.)

Insulation thickness: 0.5mm(min.)

0.5mm(min.)





- **ANODE** 1:
- **CATHODE**
- N.C.
- **TERMINAL 1**
- **TERMINAL 2**

(ZC: Zero-cross Circuit)

Start of commercial production 1993-05

#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristic		Symbol	Rating	Unit
	Forward current	l <sub>F</sub>	30	mA	
	Forward current derating (Ta ≥ 2	ΔI <sub>F</sub> / °C	-0.3	mA / °C	
	Peak forward current (100μs pu	se, 100pps)	IFP	1	A
LED	Reverse voltage		VR	5	V ((
	Input power dissipation		PD	100	mW
	Input power dissipation derating	(Ta≥25°C)	ΔP <sub>D</sub> /°C	-1.0	mW/°C /
	Junction temperature		Tj	125	, e
	Off-state output terminal voltage	$V_{DRM}$	600	V	
	On state PMS current	Ta=25°C	IT(DMC)	100	
	OII-State RIVIS Current	Ta=70°C	IF   30   m     ΔIF / °C   -0.3   mA     DPS   IFP   1   A     VR   5   V     PD   100   m     °C   ΔPD / °C   -1.0   m     VDRM   600   V     °C   IT(RMS)   50   m     ΔIT / °C   1.1   mA     DPS   ITP   2   A     PO   300   m     TS   15   0     TS   55 to 150   0     TS   260   0     C   TS   260   0     TS   260   0	) )	
Detector	On–state current derating (Ta ≥ 25°C)	ΔI <sub>T</sub> / °C		mA / °C	
stecto	Forward current $I_F$ 30  Forward current derating (Ta $\geq$ 25°C) $\Delta I_F$ /°C -0.3  Peak forward current (100 $\mu$ s pulse, 100pps) $I_{FP}$ 1  Reverse voltage $V_R$ 5  Input power dissipation $P_D$ 100  Input power dissipation derating (Ta $\geq$ 25°C) $\Delta P_D$ /°C -1.0  Junction temperature $T_j$ 125  Off-state output terminal voltage $V_{DRM}$ 600  On-state RMS current $T_{Ta}=25^{\circ}C$ $T_{Ta}=70^{\circ}C$ 100  On-state current derating (Ta $\geq$ 25°C) $T_{Ta}=25^{\circ}C$ $T_{Ta}$	<b>A</b>			
ŏ			ITSM	1.2	A
	Output power dissipation		PO	300	mW
	Output power dissipation deratir	∆PO/°C	-3.0	mW/°C	
	Junction temperature	Tj	115	/( ·c)	
Storage	e temperature range	4	T <sub>stg</sub>	-55 to 150	°C
Operat	ing temperature range		Topr	-40 to 100	°C
Lead s	oldering temperature (10 s)		)) T <sub>sol</sub>	260	°C
	on voltage 0 s., R.H. ≤ 60 %)	(Note 1)	BVs	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Device considered a two terminal device=Pins 1, 2 and 3 shorted together and pins 4 and 6 shorted together.

### **Recommended Operating Conditions**

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V <sub>A</sub> C	_	_	240	Vac
Forward current	lF	4.5	6	7.5	mA
Peak on-state current	ITP	_	_	1	Α
Operating temperature	T <sub>opr</sub>	-10	_	85	°C

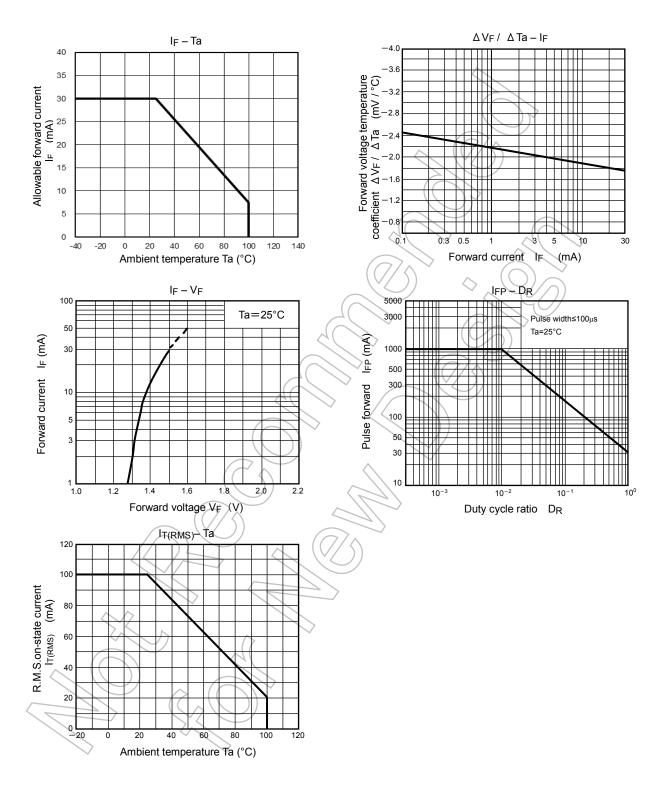
Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

### Individual Electrical Characteristics (Ta = 25°C)

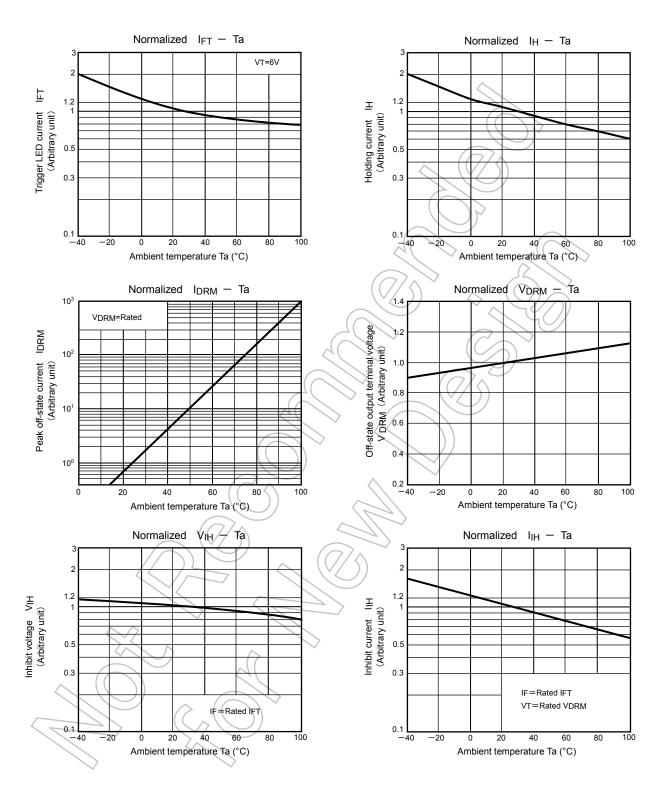
Characteristic		Symbol	Test Condition	Min.	Тур.	Max.	Unit
LED	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.2	1.4	1.7	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 3 V	_	_	10	μА
	Capacitance	СТ	V=0 V, f = 1 MHz	/	30	_	pF
Detector	Peak off-state current	I <sub>DRM</sub>	V <sub>DRM</sub> = 600 V		10	1000	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> = 100 mA		) –	3.0	V
	Holding current	lн	- \ (7)	<u> </u>	0.6	_	mA
	Critical rate of rise of off–state voltage	dv / dt	V <sub>in</sub> = 240 ms Ta = 85 °C	200	500	-	V / μs
	Critical rate of rise of commutating voltage	dv / dt(c)	V <sub>in</sub> = 60 Vrms I <sub>T</sub> = 15 mArms		0.2	-	V / μs

## Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min.	Týp.	Max.	Unit
Trigger LED current	lfT	V <sub>T</sub> = 3 V, resistive load	<i>⊋ -</i> //		3	mA
Inhibit voltage	VIH	IF = rated IFT		_	50	V
Leakage in inhibited state	IIH (	IF = rated IFT VT = rated VDRM		ı	600	μΑ
Capacitance input to output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	リ <b>ー</b>	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500V, R.H. ≤ 60 %	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVs	AC, 60 s	5000	_	_	Vrms



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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